



Sense and Drive the World



SYN500R Datasheet
(300-450MHz ASK Receiver)
Version 1.0

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1. General Description

The SYN500R is a general purpose, 3V-5.5V ASK Receiver that operates at 300-450MHz with typical sensitivity of -109dBm.

The SYN500R functions as a super-heterodyne receiver for OOK and ASK modulation up to 10kbps. The down-conversion mixer also provides image rejection. All post-detection data filtering is provided on the SYN500R. Any one-of-four filter bandwidths may be selected externally by the user in binary steps, from 1.25KHz to 10KHz. The user need only configure the device with a set of easily determined values, based upon data rate, code modulation format, and desired duty-cycle operation.

SYN510R is the SOP16 package version. SYN520R is the SOP8 package version.

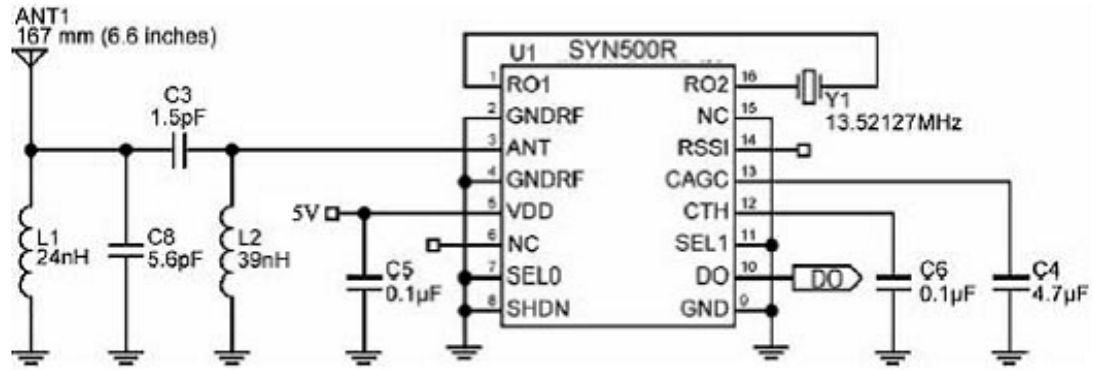
2. Features

- - 109 dBm sensitivity, 1kbps and BER 10E-02
- Frequency from 300MHz to 450MHz
- Supply Voltage from 3V to 5.5V
- Image Rejection Mixer Data-rate up to 10kbps (fixed-mode)
- Low power, 6.0mA, 3.3V @ 433.92MHz, 3.9mA, 3.3V @315MHz, continuous on data rates to 10kbps (Manchester Encoded)
- Analog RSSI Output
- No IF filter required
- Excellent selectivity and noise rejection

3. Applications

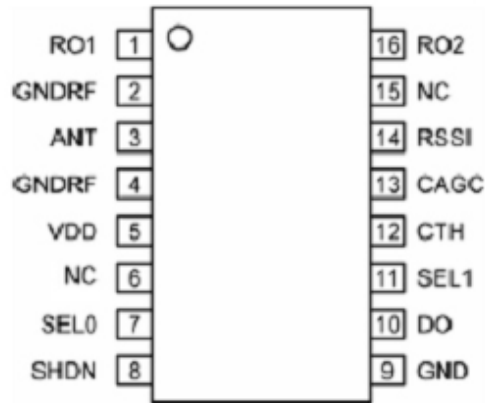
- Automotive Remote Keyless Entry (RKE)
- Remote controls
- Remote fan and light control
- Garage door and gate openers

4. Typical Application

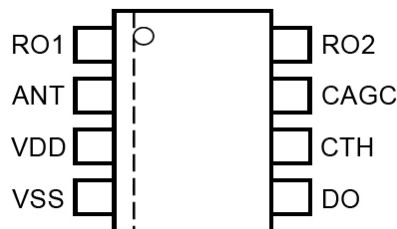


433.92MHz 1K Baud Rate Example

5. Pin Configuration



SYN500R SSOP16 and SYN510R SOP16



SYN520R SOP8

6. Pin Description

SSOP16	Pin Name	Pin Function
1	RO1	Reference resonator input connection to Colpitts oscillator stage. May also be driven by external reference signal of 1.5V p-p amplitude maximum.
2	GNDRF	Negative supply connection associated with ANT RF input.
3	ANT	RF signal input from antenna. Internally AC coupled. It is recommended that a matching network with an inductor -to-RF ground is used to improve ESD protection.
4	GNDRF	Negative supply connection associated with ANT RF input.
5	VDD	Positive supply connection for all chip functions.
6	NC	Not Connected (Floating)
7	SEL0	Logic control input with active internal pull-up. Used in conjunction with SEL1 to control the demodulator low pass filter bandwidth. (See filter table for SEL0 and SEL1 in application section)
8	SHDN	Shutdown logic control input. Active internal pull-up.
9	GND	Negative supply connection for all chip functions except RF input.
10	DO	Demodulated data output.
11	SEL1	Logic control input with active internal pull-up. Used in conjunction with SEL0 to control the demodulator low pass filter bandwidth. (See filter table for SEL0 and SEL1 in application section)
12	CTH	Demodulation threshold voltage integration capacitor connection. Tie an external capacitor across CTH pin and GND to set the settling time for the demodulation data slicing level. Values above 1nF are recommended and should be optimized for data rate and data profile.
13	CAGC	AGC filter capacitor connection. CAGC capacitor, normally greater than 0.47 μ F, is connected from this pin to GND
14	RSSI	Received signal strength indication output. Output is from a buffer with 200 Ω typical output impedance.
15	NC	Not Connected (Connect to Ground)
16	RO2	Reference resonator input connection to Colpitts oscillator stage, a 18pF capacitor is connected from this pin to GND during normal operation.

7. Absolute Maximum Ratings (Note 1)

Supply Voltage (V_{DD})	+7V
Input Voltage	+7V
Junction Temperature (T_J)	+150°C
Storage Temperature Range (T_S)	-65°C to +150°C
Lead Temperature (soldering, 10 sec.)	+260°C
Maximum Receiver Input Power	+10dBm
ESD Rating	Note 3

8. Operating Ratings (Note 2)

RF Frequency Range	300MHz to 450MHz
Supply Voltage (V_{DD})	+3.0V to +5.5V
Input Voltage (V_{IN})	5.5V (Max)
Maximum Input RF Power	- 20dBm
Ambient Temperature (T_A)	-30°C to +85°C

9. Electrical Characteristics (Note 4)

Specifications apply for $3.0V < V_{DD} < 5.5V$, $V_{SS} = 0V$, $C_{AGC} = 4.7\mu F$, $C_{TH} = 0.1\mu F$, $f_{RX} = 433.92$ MHz, unless otherwise noted. **Bold** values indicate $-40^\circ C - T_A - 105^\circ C$. 1kpbs data rate (Manchester encoded), reference oscillator frequency = 13.52127MHz.

Symbol	Parameter	Condition	Min	Typ	Max	Units
I_{SS}	Operating Supply Current	$V_{DD}=3.3V$, $f_{RX} = 433.92MHz$		6.0		mA
		$V_{DD}=5V$, $f_{RX} = 433.92MHz$		7.0		mA
		$V_{DD}=3.3V$, $f_{RX} = 315MHz$		3.9		mA
		$V_{DD}=5V$, $f_{RX} = 315MHz$		4.7		mA
I_{SHUT}	Shut down Current			0.5		μA

RF Section, IF Section

	Image Rejection			20		dB
	1 st IF Center Frequency	$f_{RX} = 433.92MHz$		1.2		MHz
		$f_{RX} = 315MHz$		0.86		MHz

Receiver Sensitivity @ 1kbps	$f_{RX} = 433.92\text{MHz}$, $V_{DD}=5\text{V}$ (matched to 50 Ω) BER= 10^{-2}	-109		dBm
	$f_{RX} = 315\text{MHz}$, $V_{DD}=5\text{V}$ (matched to 50 Ω) BER= 10^{-2}	-109		dBm
IF Bandwidth	$f_{RX} = 433.92\text{MHz}$	330		kHz
	$f_{RX} = 315\text{MHz}$	235		kHz
Antenna Input Impedance	$f_{RX} = 433.92\text{MHz}$	19 – j174		Ω
	$f_{RX} = 315\text{MHz}$	32.5 – j235		Ω
Receive Modulation Duty Cycle	Note 5	20	80	%
AGC Attack / Decay Ratio	t_{ATTACK} / t_{DECAY}	0.1		
AGC pin leakage current	$T_A = 25^\circ\text{C}$	± 2		nA
	$T_A = +105^\circ\text{C}$	± 800		nA
AGC Dynamic Range	RF_{IN} @ -40dBm	1.15		V
	RF_{IN} @ -100dBm	1.70		V

Reference Oscillator

Reference Oscillator Frequency	$f_{RX} = 433.92\text{ MHz}$ Crystal Load Cap = 10pF	13.52127		MHz
	$f_{RX} = 315\text{ MHz}$ Crystal Load Cap = 10pF	9.81563		MHz
Reference Oscillator Input Impedance		300		k Ω
Reference Oscillator Input Range		0.2	1.5	Vp-p
Reference Oscillator Source Current	$V(\text{REFOSC}) = 0\text{V}$	3.5		μA

Demodulator

CTH Source Impedance	$F_{\text{REFOSC}} = 13.52127\text{MHz}$	120		k Ω
	$F_{\text{REFOSC}} = 9.81563\text{MHz}$	165		k Ω
CTH Leakage Current	$T_A = 25^\circ\text{C}$	± 2		nA
	$T_A = +105^\circ\text{C}$	± 800		nA
Demodulator Filter Bandwidth @ 434MHz	Programmable, see application section	1625	13000	Hz

Digital/Control Section

	DO pin output current	As output source @ 0.8 Vdd sink @ 0.2 Vdd		260 600		μ A
	Output rise and fall times	CI = 15pF, pin DO, 10-90%		2		μ sec

RSSI

	RSSI DC Output Voltage Range			0.4 to 2		V
	RSSI response slope	-109dBm to -40dBm		25		mV/dB
	RSSI Output Current			400		μ A
	RSSI Output Impedance			200		Ω
	RSSI Response Time	50% data duty cycle, input power to Antenna = -20dBm		0.3		sec

Note 1: Exceeding the absolute maximum rating may damage the device.

Note 2: The device is not guaranteed to function outside of its operating rating.

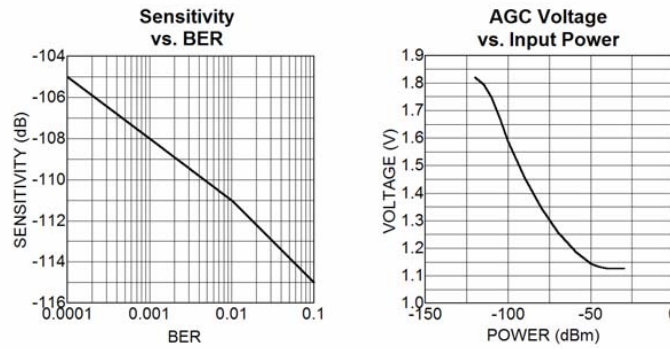
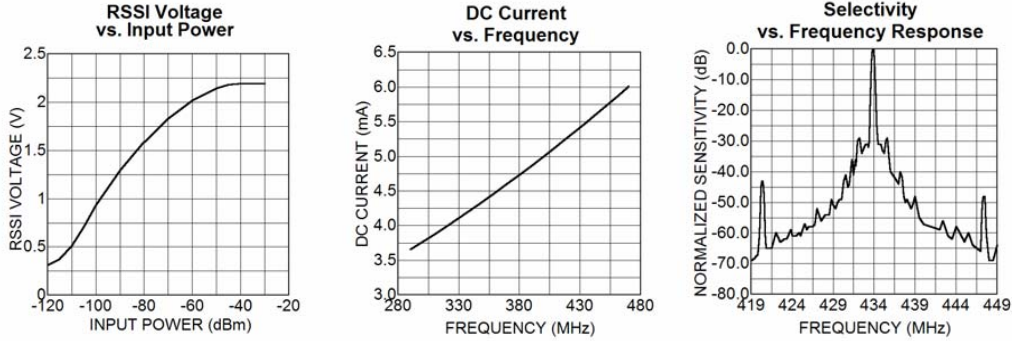
Note 3: Device is ESD sensitive. Use appropriate ESD precautions. Exceeding the absolute maximum rating may damage the device.

Note 4: Sensitivity is defined as the average signal level measured at the input necessary to achieve 10⁻² BER (bit error rate). The input signal is defined as a return-to-zero (RZ) waveform with 50% average duty cycle (Manchester encoded) at a data rate of 1kbps.

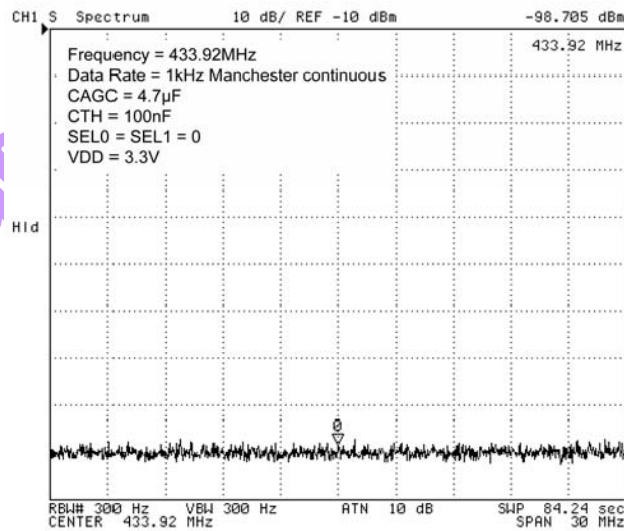
Note 5: When data burst does not contain preamble, duty cycle is defined as total duty cycle, including any “quiet” time between data bursts. When data bursts contain preamble sufficient to charge the slice level on capacitor C_{TH}, then duty cycle is the effective duty cycle of the burst alone. [For example, 100msec burst with 50% duty cycle, and 100msec “quiet” time between bursts. If burst includes preamble, duty cycle is $T_{ON}/(T_{ON}+T_{OFF})= 50\%$; without preamble, duty cycle is $T_{ON}/(T_{ON}+T_{OFF}+T_{QUIET}) = 50\text{msec}/(200\text{msec})=25\%$. T_{ON} is the (Average number of 1's/burst) \times bit time, and $T_{OFF}=T_{BURST}-T_{ON}$.]

10. Typical Characteristics

10.1. Sensitivity Graphs



LO Leakage in RF Port



11. Functional Diagram

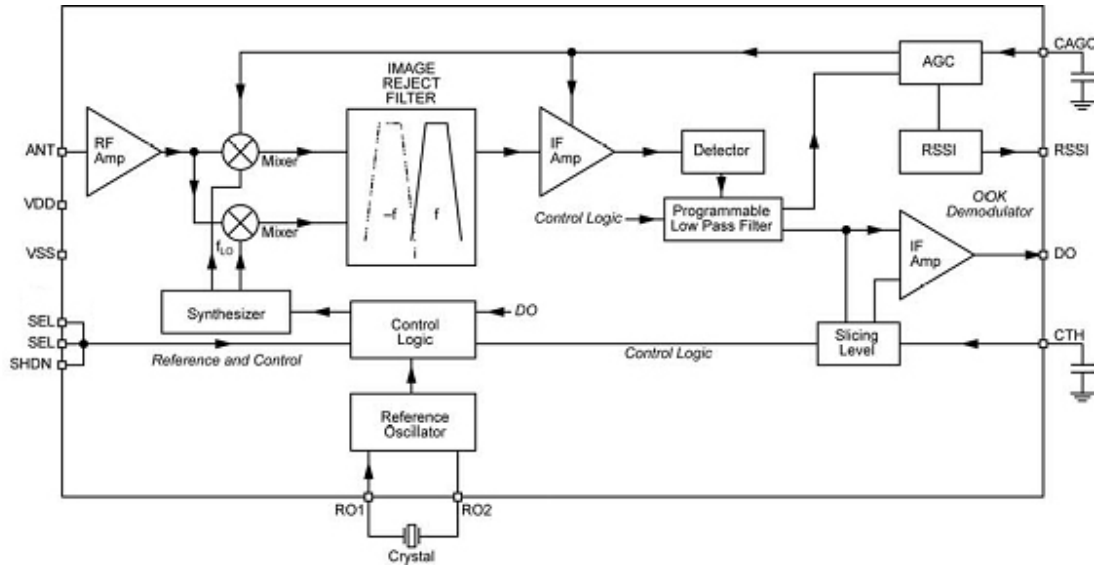


Figure 1. Simplified Block Diagram

12. Functional Description

Figure 1. Simplified Block Diagram that illustrates the basic structure of the SYN500R. It is made of three sub-blocks; Image Rejection UHF Down-converter, the OOK Demodulator, and Reference and Control Logics. Outside the device, the SYN500R requires only three components to operate: two capacitors (CTH, and CAGC) and the reference frequency device, usually a quartz crystal. An additional five components may be used to improve performance. These are: power supply decoupling capacitor, two components for the matching network, and two components for the pre-selector band pass filter.

13. Receiver Operation

13.1. LNA

The RF input signal is AC-coupled into the gate circuit of the grounded source LNA input stage. The LNA is a Cascoded NMOS.

13.2. Mixers and Synthesizer

The LO ports of the Mixers are driven by quadrature local oscillator outputs from the synthesizer block. The local oscillator signal from the synthesizer is placed on the low side of the desired RF signal to allow suppression of the image frequency at twice the IF frequency below the wanted signal. The local oscillator is set to 32 times the crystal reference frequency via a phase-locked

loop synthesizer with a fully integrated loop filter.

13.3. Image Reject Filter and Band-Pass Filter

The IF ports of the mixer produce quadrature down converted IF signals. These IF signals are low-pass filtered to remove higher frequency products prior to the image reject filter where they are combined to reject the image frequencies. The IF signal then passes through a third order band pass filter. The IF center frequency is 1.2MHz. The IF BW is 330kHz @ 433.92MHz, and this varies with RF operating frequency. The IF BW can be calculated via direct scaling:

$$BW_{IF} = BW_{IF@433.92\text{ MHz}} \times \frac{\text{Operating Freq(MHz)}}{433.92}$$

These filters are fully integrated inside the SYN500R.

After filtering, four active gain controlled amplifier stages enhance the IF signal to proper level for demodulation.

13.4. OOK Demodulator

The demodulator section is comprised of detector, programmable low pass filter, slicer, and AGC comparator.

13.5. Detector and Programmable Low-Pass Filter

The demodulation starts with the detector removing the carrier from the IF signal. Post detection, the signal becomes base band information. The programmable low-pass filter further enhances the base band information. There are four programmable low-pass filter BW settings: 1625Hz, 3250Hz, 6500Hz, 13000Hz for 433.92MHz operation. Low pass filter BW will vary with RF Operating Frequency. Filter BW values can be easily calculated by direct scaling. See equation below for filter BW calculation:

$$BW_{\text{Operating Freq}} = BW_{@433.92\text{MHz}} \times \frac{\text{Operating Freq(MHz)}}{433.92}$$

It is very important to choose the filter setting that best fits the intended data rate to minimize data distortion.

Demod BW is set at 13000Hz @ 433.92MHz as default (assuming both SEL0 and SEL1 pins are floating). The low pass filter can be hardware set by external pins SEL0 and SEL1.

SEL0	SEL1	Demod BW (@ 434MHz)
0	0	1625Hz
1	0	3250Hz
0	1	6500Hz
1	1	13000Hz-default

Table 1: Demodulation BW Selection

13.6. Slicer, Slicing Level

The signal prior to slicer is still linear demodulated AM. Data slicer converts this signal into digital “1”s and “0”s by comparing with the threshold voltage built up on the CTH capacitor. This threshold is determined by detecting the positive and negative peaks of the data signal and storing the mean value. Slicing threshold default is 50%. After the slicer the signal is now digital OOK data .

During long periods of “0”s or no data period, threshold voltage on the CTH capacitor may be very low. Large random noise spikes during this time may cause erroneous “1”s at DO pin.

13.7. AGC Comparator

The AGC comparator monitors the signal amplitude from the output of the programmable low-pass filter. When the output signal is less than 750mV thresh-hold, 1.5 μ A current is sourced into the external CAGC capacitor. When the output signal is greater than 750mV, a 15 μ A current sink discharges the CAGC capacitor. The voltage developed on the CAGC capacitor acts to adjust the gain of the mixer and the IF amplifier to compensate for RF input signal level variation.

13.8. Reference Control

There are 2 components in Reference and Control sub-block:

- 1) Reference Oscillator
- 2) Control Logic through parallel Inputs: SEL0, SEL1, SHDN

13.9. Reference Oscillator

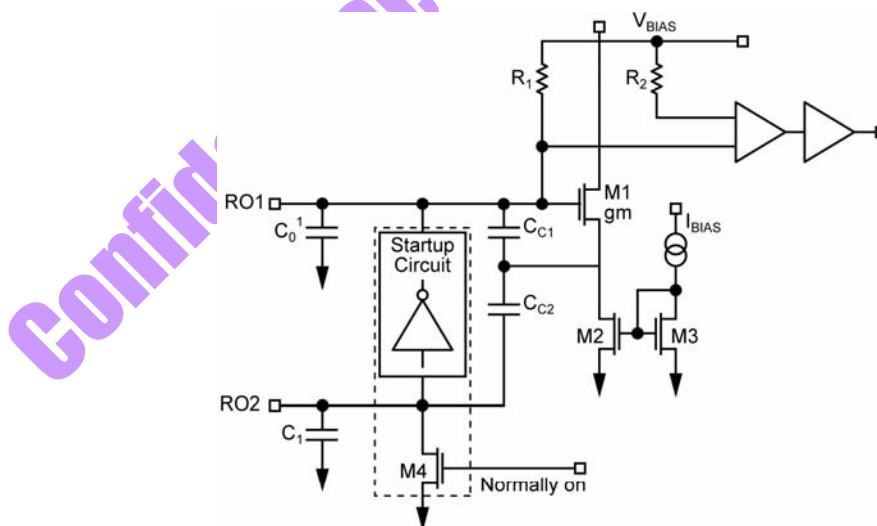


Figure 2: Reference Oscillator Circuit

The reference oscillator in the SYN500R (Figure 2) uses a basic Colpitts crystal oscillator configuration with MOS transconductor to provide negative resistance. All capacitors shown in Figure 2 are integrated inside SYN500R. RO1 and RO2 are external pins of SYN500R. User only needs to connect reference oscillation crystal.

Reference oscillator crystal frequency can be calculated:

$$F_{REF OSC} = F_{RF} / (32 + 1.1/12)$$

For 433.92 MHz, $F_{REF OSC} = 13.52127$ MHz.

To operate the SYN500R with minimum offset, crystal frequencies should be specified with 10pF loading capacitance.

14. Applications Information

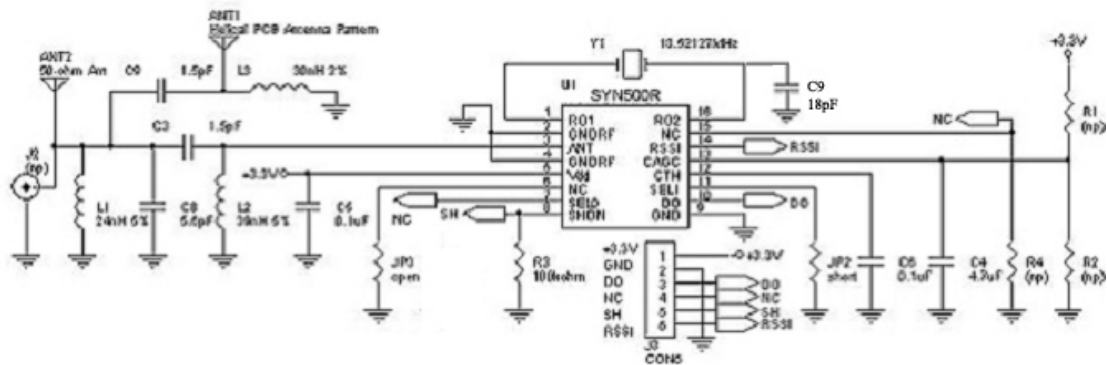


Figure 3. SYN500R Application Example, 433.92 MHz

The SYN500R can be fully tested by using one of many evaluation boards designed at Synoxo for this device. As an entry level, the SYN500R evaluation board (Figure 3) offers a good start for most applications. It has a helical PCB antenna with its matching network, a band-pass-filter front-end as a pre-selector filter, matching network and the minimum components required to make the device work, which are a crystal, Cagc, and Cth capacitors. By removing the matching network of the helical PCB antenna (C9 and L3), a whip antenna (ANT2) or a RF connector (J2) can be used instead. Figure 3 shows the entire schematic of it for 433.92MHz. Other frequencies can be used and the values needed are in the tables below.

Capacitor C9 and inductor L3 are the passive elements for the helical PCB matching network. A tight tolerance is recommended for these devices, like 2% for the inductor and 0.1pF for the capacitor. PCB variations may require different values and optimization. Table 2 shows the matching elements for the device frequency range. For additional information look for Small PCB Antennas for Synoxo RF Products application note.

Freq(MHz)	C9(pF)	L3(nH)
390.0	1.2	43
418.0	1.2	36
433.92	1.5	30

Table 2. Matching Values for the Helical PCB Antenna

To use another antenna, like the whip kind, remove C9 and place the whip antenna in the hole provided in the PCB. Also, a RF signal can be injected there.

L1 and C8 form the pass-band-filter front-end. Its purpose is to attenuate undesired outside band noise which reduces the receiver performance. It is calculated by the parallel resonance equation $f = 1/(2 \times \pi \times (\text{SQRT } L1 \times C8))$. Table 3 shows the most used frequency values.

Freq(MHz)	C8(pF)	L1(nH)
390.0	6.8	24
418.0	6.0	24
433.92	5.6	24

Table 3. Band-Pass-Filter Front-End Values

There is no need for the band-pass-filter front-end for applications where it is proven that the outside band noise does not cause a problem. The SYN500R has image reject mixers which improve significantly the selectivity and rejection of outside band noise.

Capacitor C3 and inductor L2 form the L-shape matching network. The capacitor provides additional attenuation for low frequency outside band noise and the inductor provides additional ESD protection for the antenna pin. Two methods can be used to find these values, which are matched close to 50Ω. One method is done by calculating the values using the equations below and another by using a Smith chart. The latter is made easier by using software that plots the values of the components C8 and L1, like WinSmith by Noble Publishing.

To calculate the matching values, one needs to know the input impedance of the device. Table 4 shows the input impedance of the SYN500R and suggested matching values for the most used frequencies. These suggested values may be different if the layout is not exactly the same as the one made here.

Freq (MHz)	C3 (pF)	L2(nH)	Z device (Ω)
390.0	1.5	47	22.5 – j198.5
418.0	1.5	43	21.4 – j186.1
433.92	1.5	39	18.6 – j174.2

Table 4: matching values for the most used frequencies

For the frequency of 433.92MHz, the input impedance is $Z = 18.6 - j174.2\Omega$, then the matching components are calculated by,

$$\text{Equivalent parallel} = B = 1/Z = 0.606 + j5.68 \text{ msiemens}$$

$$R_p = 1 / \text{Re} (B); \quad X_p = 1/ \text{Im} (B)$$

$$R_p = 1.65\text{k}\Omega; \quad X_p = 176.2\Omega$$

$$Q = \text{SQRT} (R_p/50 + 1)$$

$$Q = 5.831$$

$$X_m = R_p / Q$$

$$X_m = 282.98\Omega$$

Resonance Method for L-shape Matching Network

$$L_c = X_p / (2 \times \pi \times f); \quad L_p = X_m / (2 \times \pi \times f)$$

$$L_2 = (L_c \times L_p) / (L_c + L_p); \quad C_3 = 1 / (2 \times \pi \times f \times X_m)$$

$$L_2 = 39.8 \text{ nH}$$

$$C_3 = 1.3 \text{ pF}$$

Doing the same calculation example with the Smith Chart, it would appear as follows,

First, we plot the input impedance of the device, ($Z = 18.6 - j174.2 \Omega$) @ 433.92 MHz. (Figure 4).

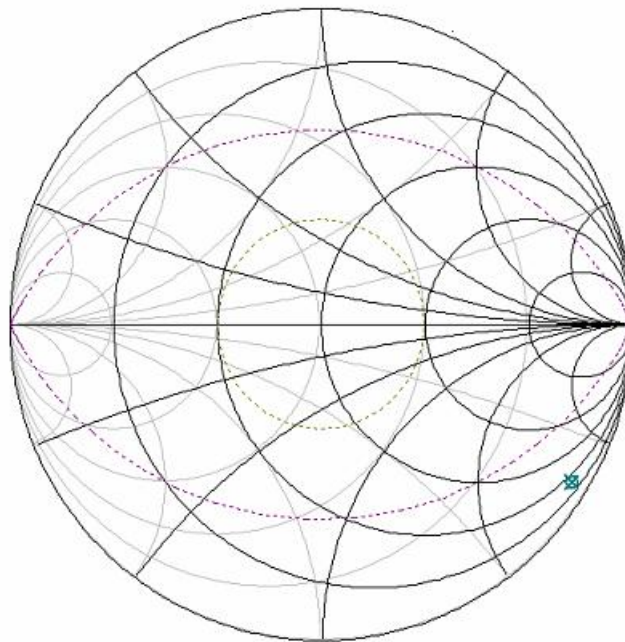


Figure 4: device's input impedance, $Z = 18.6 - j174.2 \Omega$

Second, we plot the shunt inductor (39nH) and the series capacitor (1.5pF) for the desired input impedance (Figure 5). We can see the matching leading to the center of the Smith Chart or close to 50Ω .

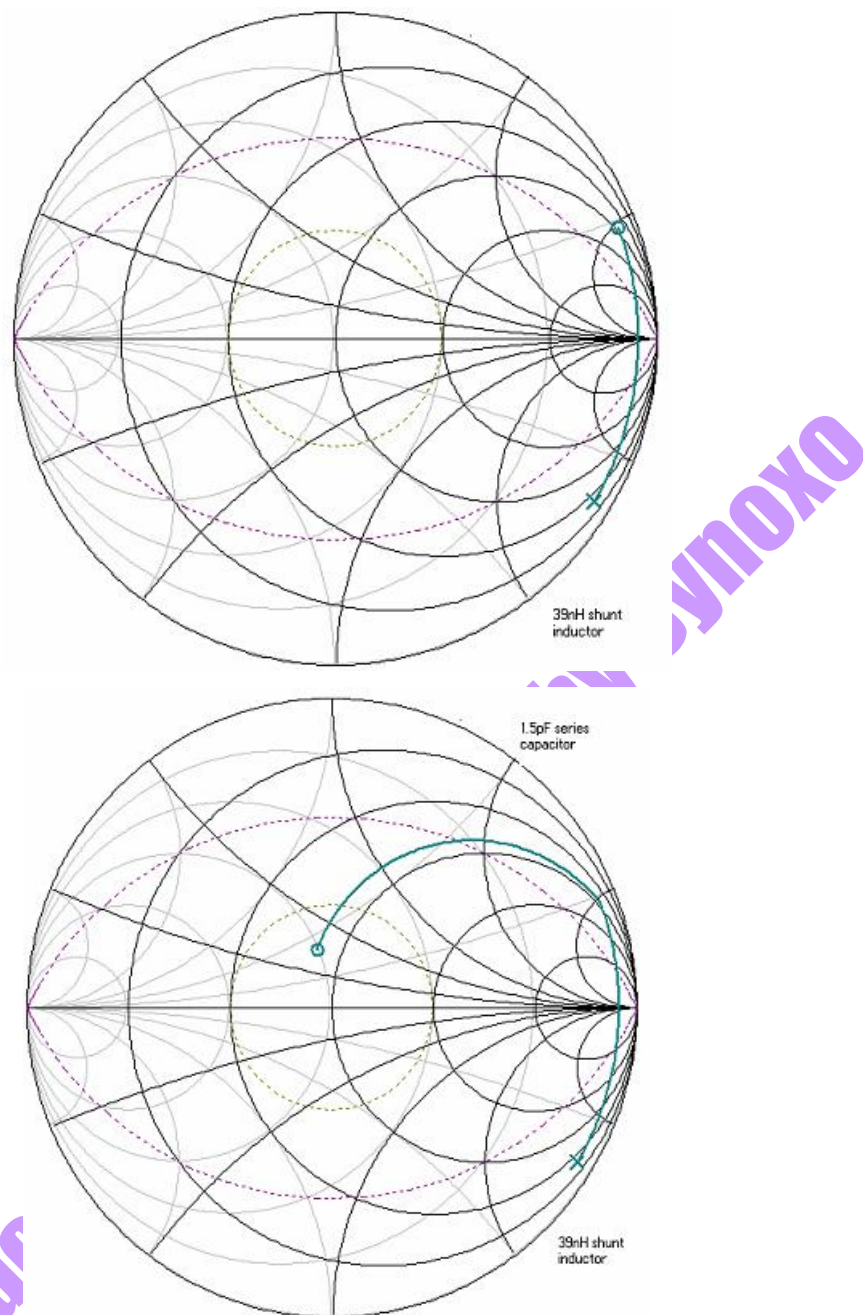


Figure 5. Plotting the Shunt Inductor and Series Capacitor.

Crystal Y1 or Y1A (SMT or leaded respectively) is the reference clock for all the device internal circuits. Crystal characteristics of 10pF load capacitance, 30ppm, ESR < 50Ω, -40°C to +105°C temperature range are desired. Table 5 shows the crystal frequencies and one of Synoxo's approved crystal manufacturers.

The oscillator of the SYN500R is a Colpitts type. It is very sensitive to stray capacitance loads. Thus, very good care must be taken when laying out the printed circuit board. Avoid long traces and ground plane on the top layer close to the REFOSC pins RO1 and RO2. When care is not taken in the layout, and crystals from other vendors are used, the oscillator may take longer times to start as well as the time to good data in the DO pin to show up. In some cases, if the stray capacitance is too high (> 20pF), the oscillator may not start at all.

The crystal frequency is calculated by $REFOSC = RF \text{ Carrier} / (32 + (1.1/12))$. The local oscillator is low side injection ($32 \times 13.52127\text{MHz} = 432.68\text{MHz}$), that is, its frequency is below the RF carrier frequency and the image frequency is below the LO frequency. See Figure 6. The product of the incoming RF signal and local oscillator signal will yield the IF frequency, which will be demodulated by the detector of the device.

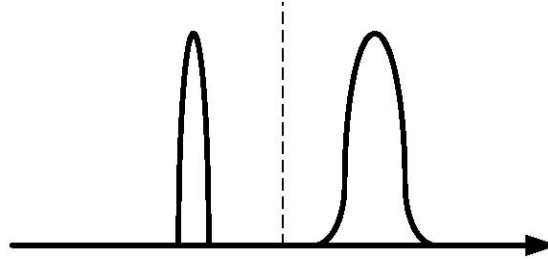


Figure 6. Low Side Injection Local Oscillator.

REFOSC (MHz)	Carrier (MHz)	Part Number
12.15269	390.0	SA-12.152690-F-10-H-30-30-X
13.02519	418.0	SA-13.025190-F-10-H-30-30-X
13.52127	433.92	SA-13.521270-F-10-H-30-30-X

Table 5. Crystal Frequency and Vendor Part Number.

JP1 and JP2 are the bandwidth selection for the demodulator bandwidth. To set it correctly, it is necessary to know the shortest pulse width of the encoded data sent in the transmitter. Like in the example of the data profile in the figure 7 below, PW2 is shorter than PW1, so PW2 should be used for the demodulator bandwidth calculation which is found by $0.65/\text{shortest pulse width}$. After this value is found, the setting should be done according to Table 6. For example, if the pulse period is $100\mu\text{sec}$, 50% duty cycle, the pulse width will be $50\mu\text{sec}$ ($PW = (100\mu\text{sec} \times 50\%) / 100$). So, a bandwidth of 13kHz would be necessary ($0.65 / 50\mu\text{sec}$). However, if this data stream had a pulse period with 20% duty cycle, the bandwidth required would be 32.5kHz ($0.65 / 20\mu\text{sec}$), which exceeds the maximum bandwidth of the demodulator circuit. If one tries to exceed the maximum bandwidth, the pulse would appear stretched or wider.

SEL0 JP1	SEL1 JP2	Demod. BW (hertz)	Shortest Pulse (μsec)	Maximum baud rate for 50% Duty Cycle (hertz)
Short	Short	1625	400	1250
Open	Short	3250	200	2500
Short	Open	6500	100	5000
Open	Open	13000	50	10000

Table 6. JP1 and JP2 setting, 433.92 MHz.

Other frequencies will have different demodulator bandwidth limits, which are derived from the reference oscillator frequency. Table 7 and Table 8 below shows the limits for the other two most used frequencies.

SEL0 JP1	SEL1 JP2	Demod. BW (hertz)	Shortest Pulse (μ sec)	Maximum baud rate for 50% Duty Cycle (hertz)
Short	Short	1565	416	1204
Open	Short	3130	208	2408
Short	Open	6261	104	4816
Open	Open	12523	52	9633

Table 7. JP1 and JP2 setting, 418.0 MHz.

SEL0 JP1	SEL1 JP2	Demod. BW (hertz)	Shortest Pulse (μ sec)	Maximum baud rate for 50% Duty Cycle (Hertz)
Short	Short	1460	445	1123
Open	Short	2921	223	2246
Short	Open	5842	111	4493
Open	Open	11684	56	8987

Table 8. JP1 and JP2 setting, 390.0 MHz.

Capacitors C6 and C4, C_{TH} and C_{AGC} respectively provide time base reference for the data pattern received. These capacitors are selected according to data profile, pulse duty cycle, dead time between two received data packets, and if the data pattern has or does not have a preamble. See Figure 7, example of a data profile.

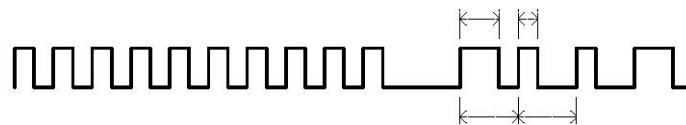


Figure 7. Example of a Data Profile.

For best results the capacitors should always be optimized for the data pattern used. As the baud rate increases, the capacitor values decrease. Table 9 shows suggested values for Manchester Encoded data, 50% duty cycle.

SEL0 JP1	SEL1 JP2	Demod. BW (hertz)	C _{TH}	C _{AGC}

Short	Short	1625	100nF	4.7 μ F
Open	Short	3250	47nF	2.2 μ F
Short	Open	6500	22nF	1 μ F
Open	Open	13000	10nF	0.47 μ F

Table 9. Suggested C_{TH} and C_{AGC} Values.

Other components used are C5, which is a decoupling capacitor for the V_{DD} line, R4 reserved for future use and not needed for the evaluation board, R3 for the shutdown pin (SHDN = 0, device is operation), which can be removed if that pin is connected to a microcontroller or an external switch, R1 and R2 which form a voltage divider for the AGC pin. One can force a voltage in this AGC pin to purposely decrease the device sensitivity. Special care is needed when doing this operation, as an external control of the AGC voltage may vary from lot to lot and may not work the same for several devices.

Three other pins are worthy of comment. They are the DO, RSSI, and shut down pins. The DO pin has a driving capability of 0.4mA. This is good enough for most of the logic family ICs in the market today. The RSSI pin provides a transfer function of the RF signal intensity vs voltage. It is very useful to determine the signal to noise ratio of the RF link, crude range estimate from the transmitter source and AM demodulation, which requires a low C_{AGC} capacitor value.

The shut down pin (SHDN) is useful to save energy. When its level close to V_{DD} (SHDN = 1), the device is not in operation. Its DC current consumption is less than 1 μ A (do not forget to remove R3). When toggling from high to low, there will be a time required for the device to come to steady state mode, and a time for data to show up in the DO pin. This time will be dependent upon many things such as temperature, crystal used, and if there is an external oscillator with faster startup time. Normally, with the crystal vendors suggested, the data will show up in the DO pin around 1msec time, and 2msec over the temperature range of the device. When using an external oscillator or reference oscillator signal, the time is reduced considerably and can be around 140 μ sec. See Figures Figure 10 and 11.

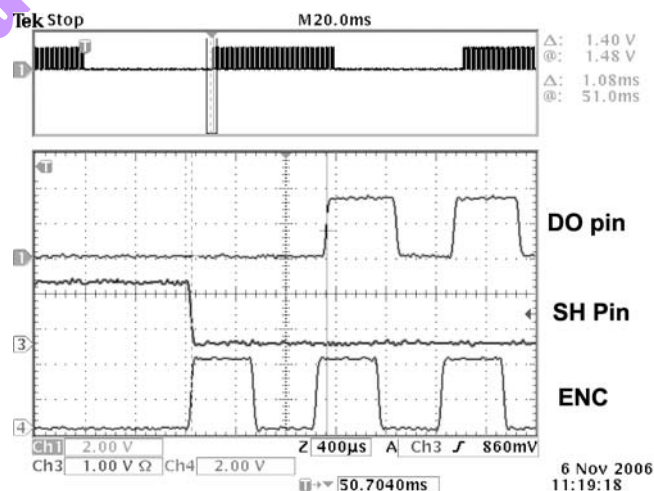


Figure 10: Time-to-Good Data After Shut Down Cycle, Room Temperature.

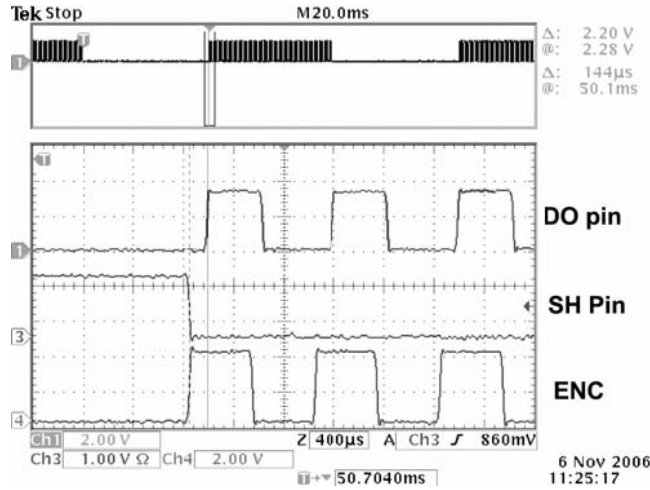
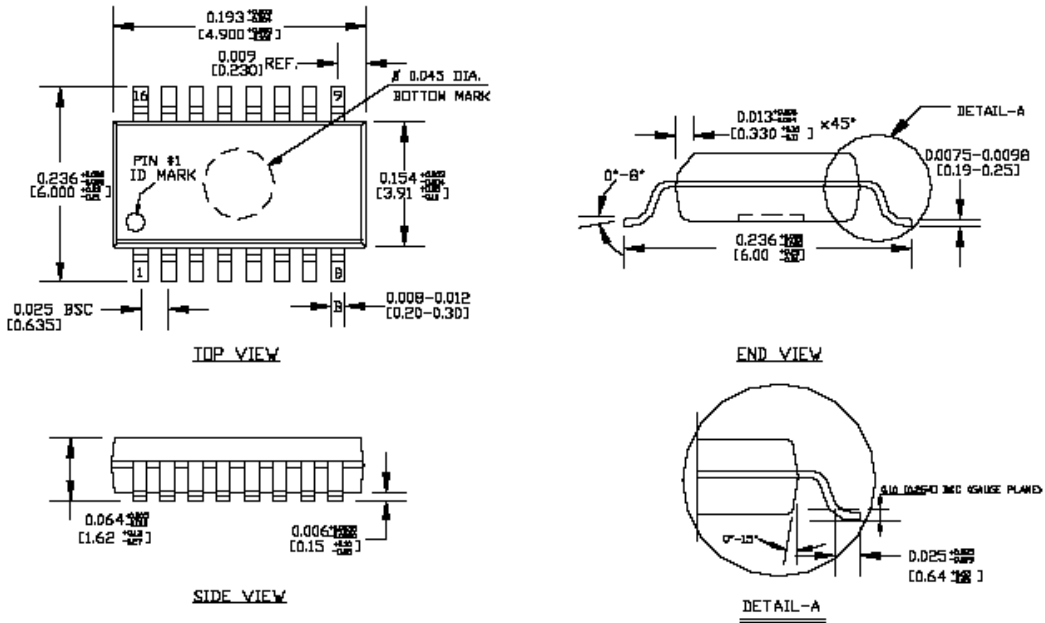


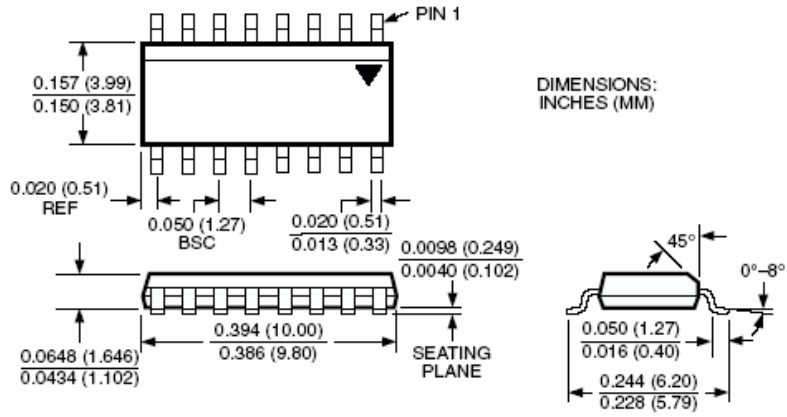
Figure 11. Time to Good Data, External Oscillator, Room Temperature.

15. Package Information

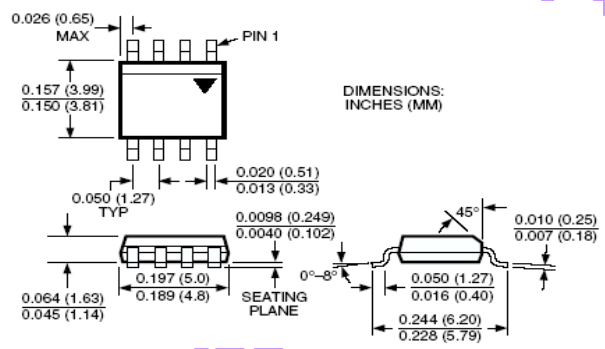


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